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Fairchild Semiconductor FDS9431A

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Distributor of Fairchild Semiconductor: Excellent Integrated System Limited Datasheet of FDS9431A - MOSFET P-CH 20V 3.5A 8SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



FDS9431A P-Channel 2.5V Specified MOSFET

General Description

This P-Channel 2.5V specified MOSFET is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

Applications

- DC/DC converter
- Power management
- Load switch
- · Battery protection

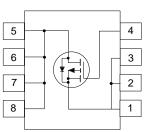
September 1999

FDS9431A

Features

- -3.5 A, -20 V. $R_{DS(ON)} = 0.130 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.180 \ \Omega \ @ V_{GS} = -2.5 \ V.$
- · Fast switching speed.
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability.





Absolute Maximum Ratings $T_A=25^{\circ}C$ unless otherwise noted Ratings Symbol Parameter Units VDSS **Drain-Source Voltage** -20 Gate-Source Voltage V_{GSS} ±8 I_D Drain Current - Continuous -3.5 (Note 1a) - Pulsed -18 P_{D} Power Dissipation for Single Operation 2.5 W (Note 1a) (Note 1b) 1.2 (Note 1c) 1.0 T_J, T_{stg} Operating and Storage Junction Temperature Range -55 to +150 °C **Thermal Characteristics**

R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information						
Device Marking	Device	Reel Size	Tape width	Quantity		
FDS9431A	FDS9431A	13"	12mm	2500 units		

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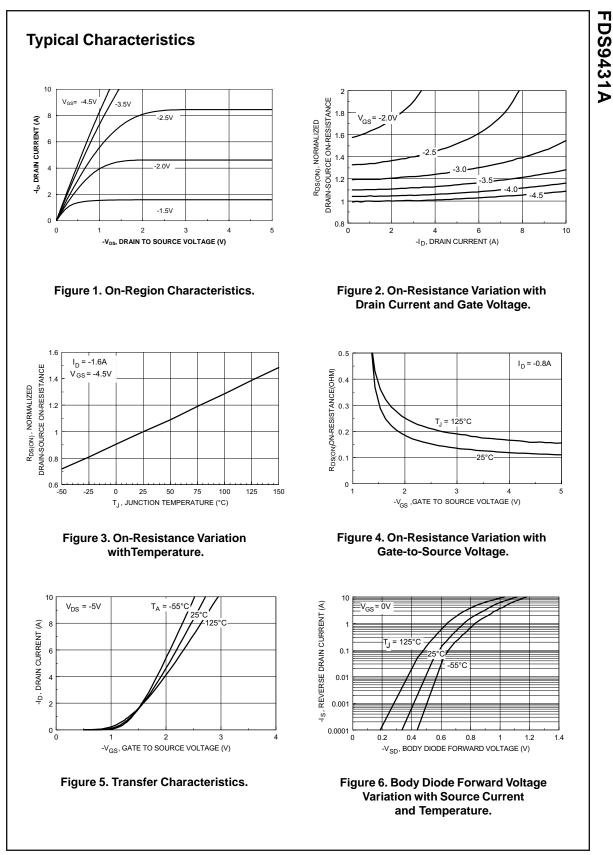
Parameter	Test Conditions	Min	Тур	Max	Units
acteristics			·		
Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-20			V
Breakdown Voltage Temperature Coefficient	I_D = -250 µA,Referenced to 25°C		-28		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = -16$ V, $V_{GS} = 0$ V			-1	μA
Gate-Body Leakage Current, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
Gate-Body Leakage Current, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
acteristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-0.6	-1	V
Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA,Referenced to 25°C		2		mV/°C
Static Drain-Source On-Resistance	$V_{GS} = -4.5 V, I_D = -3.5 A V_{GS} = -2.5 V, I_D = -3.0 A V_{GS} = -4.5 V, I_D = -3.5 A T_I = 125^{\circ}C$		0.110 0.140 0.155	0.130 0.180 0.220	Ω Ω Ω
On-State Drain Current	V _{GS} = -4.5 V, V _{DS} =-5 V	-10			Α
Forward Transconductance	$V_{DS} = -5 V, I_D = -3.5 A$		6.5		S
Characteristics		L	<u> </u>		
	$-10 V V_{00} = 0 V$	<u> </u>	405		pF
• •	f = 1.0 MHz				pr pF
			-		pF pF
		<u> </u>	10		۲.
					ns
	$V_{\rm GS} = -4.5$ V, $N_{\rm GEN} = 0.52$				ns
	'				ns
					ns
•			_	8.5	nC
Gate-Source Charge	$V_{GS} = -4.3 V$		0.8		nC
Gate-Drain Charge			1.3		nC
urce Diode Characteristics a	and Maximum Ratings				
				-2.1	Α
Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.7	-1.2	V
	Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-Body Leakage Current, Forward Gate-Body Leakage Current, Reverse acteristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain-Source On-Resistance On-State Drain Current Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance g Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Urce Diode Characteristics a Maximum Continuous Drain-Source	Drain-Source Breakdown Voltage $V_{GS} = 0$ V, $I_D = -250$ μABreakdown Voltage Temperature Coefficient $I_D = -250$ μA, Referenced to 25°CZero Gate Voltage Drain Current $V_{DS} = -16$ V, $V_{GS} = 0$ VGate-Body Leakage Current, Forward $V_{GS} = 8$ V, $V_{DS} = 0$ VGate-Body Leakage Current, Reverse $V_{GS} = -8$ V, $V_{DS} = 0$ VGate-Body Leakage Current, Reverse $V_{GS} = -8$ V, $V_{DS} = 0$ VGate-Body Leakage Current, Reverse $V_{GS} = -8$ V, $V_{DS} = 0$ VGate Threshold Voltage $V_{DS} = -250$ μA, Referenced to 25°CGate Threshold Voltage $I_D = -250$ μA, Referenced to 25°CGate Threshold Voltage $I_D = -250$ μA, Referenced to 25°CGate Threshold Voltage $I_D = -250$ μA, Referenced to 25°CGate Threshold Voltage $I_D = -250$ μA, Referenced to 25°CGate Threshold Voltage $V_{GS} = -4.5$ V, $I_D = -3.5$ AOn-Resistance $V_{GS} = -4.5$ V, $I_D = -3.5$ AOn-State Drain Current $V_{GS} = -4.5$ V, $V_{DS} = -5$ VForward Transconductance $V_{DS} = -5$ V, $I_D = -3.5$ ACharacteristics(Note 2)Turn-On Delay Time $V_{DS} = -5$ V, $I_D = -1$ A,Turn-On Rise Time $V_{DS} = -5$ V, $I_D = -3.5$ A,Gate-Source Charge $V_{DS} = -5$ V, $I_D = -3.5$ A,Gate-Source Charge $V_{DS} = -5$ V, $I_D = -3.5$ A,Gate-Drain Charge $V_{DS} = -5$ V, $I_D = -3.5$ A,Gate-Drain Charge $V_{DS} = -5$ V, $I_D = -3.5$ A,Gate-Drain Charge $V_{DS} = -5$ V, $I_D = -3.5$ A,Gate-Drain Charge $V_{DS} $	Drain-Source Breakdown Voltage $V_{GS} = 0 V$, $I_D = -250 \mu A$ -20Breakdown Voltage Temperature Coefficient $I_D = -250 \mu A$, Referenced to 25°C	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

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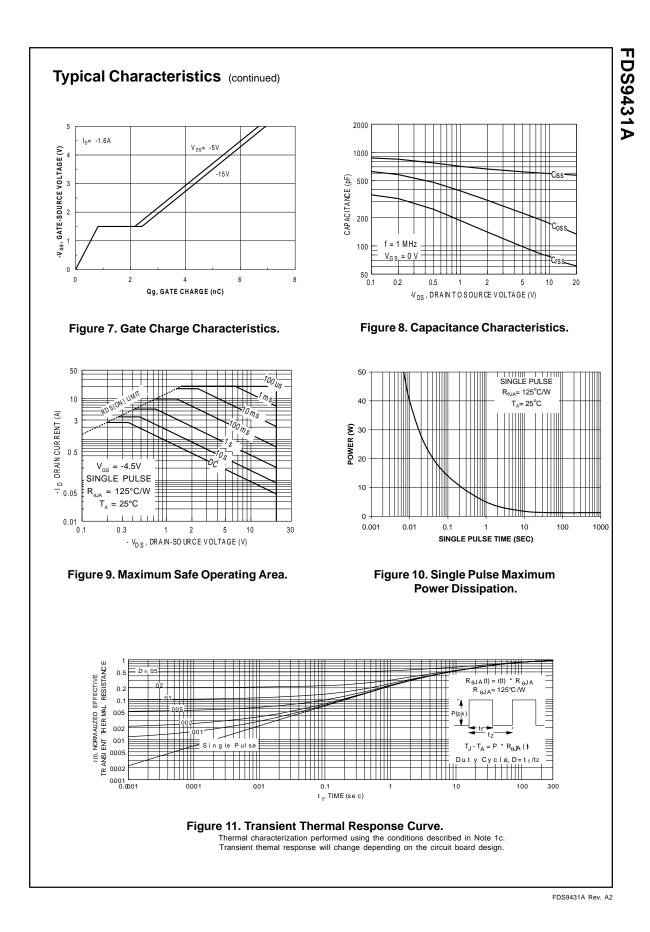


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